# Coiltronics MPI5451 Series

## High current, low profile power inductors



### Product description

- Halogen free, lead free, RoHS compliant 125°C maximum total temperature
- 5.74 x 5.43 footprint surface mount package with either 1.2 or 2.0mm
- Magnetically shielded, low EN
- Rugged construction
- J.33μH-to 15μH Jurom 1:1 to 11.5 amps

#### **Applications**

- Handheld/mobile devices
- Portable media players
- MP3 Players
- Battery operated devices
- Notebook/netbook
- Tablets/smartbooks
- LCD Displays
  - LED Drivers

### Environmental data

- Storage temperature range (Component): 40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient - self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

### **Packaging**

Supplied in tape and reel packaging on a 13" diameter reel











even more.



## **Product specifications**

Part Number <sup>5</sup>	OCL¹ (μH) ± 20%	I <sub>rms</sub> <sup>2</sup> (Amps)	I <sub>sat</sub> (Amps)	DCR (mΩ) @ 25°C ± 20%	K-Factor⁴		
R1 - 1.2mm height							
MPI5451R1-R33-R	0.33	6.5	11.5	13	1244		
MPI5451R1-R47-R	0.47	6.1	10.9	18	995		
MPI5451R1-1R0-R	1.0	4.2	7.2	30	622		
MPI5451R1-1R5-R	1.5	3.4	6.1	48	498		
MPI5451R1-2R2-R	2.2 ± 15%	2.6	4.8	70	452		
MPI5451R1-3R3-R	3.3 ± 15%	2.3	3.8	95	355		
MPI5451R1-4R7-R	4.7 ± 15%	2.1	3.5	120	293		
MPI5451R1-5R6-R	5.6 ± 15%	1.9	3.1	145	249		
MPI5451R1-6R8-R	6.8 ± 15%	1.7	2.8	175	237		
MPI5451R1-100-R	10.0 ± 15%	1.3	2.5	290	199		
MPI5451R1-150-R	15.0 ± 15%	1.1	2.2	400	155		
R3 - 2.0mm height							
MPI5451R3-R47-R	0.47	6.0	9.0	8.8	1244		
MPI5451R3-R68-R	0.68	5.9	8.0	9.5	995		
MPI5451R3-1R0-R	1.0	61 01	6.6	14	711		
MPI5451R3-1R5-R	1.5	5.0	5.8	16	553		
MPI5451R3-2R2-R	2.2	4,1	5.0	24	452		
MPI5451R3-3R3-R	3.3	3.7	4.2	33	383		
MPI5451R3-4R7-R	4.7	3.0	3.8	50	293		
MPI5451R3-6R8-R	6.8	2.6	3.0	70	249		
MPI5451R3-100-R	10.0	2.1	2.4	110	207		

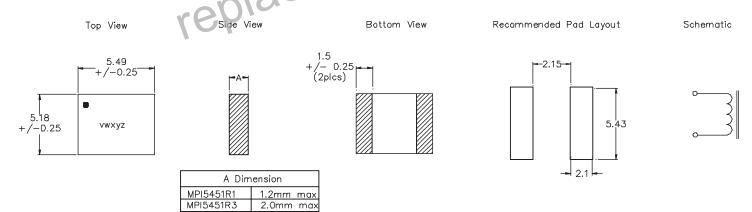
- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1V 25°C
- I<sub>ms</sub>: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC our ents. FCb layout, trace thickness and width, air-flow, and proximity of other neat generating components will a fecthe temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 3.  $I_{sat}$ : Peak current for approximately 20% rolloff at +25°C

- K-factor: Used to determine B  $_{pp}$  for core loss (see graph). B  $_{pp}$  = K \* L \*  $\Delta I$ . B  $_{pp}$ :(Gauss), K: (K-factor from table), L. (In ductance in  $\mu H$ ),  $\Delta I$  (Peak to peak ripple current in Amps).

  Part Number Definition: M.Pl. 45 i Rx-yyy-R

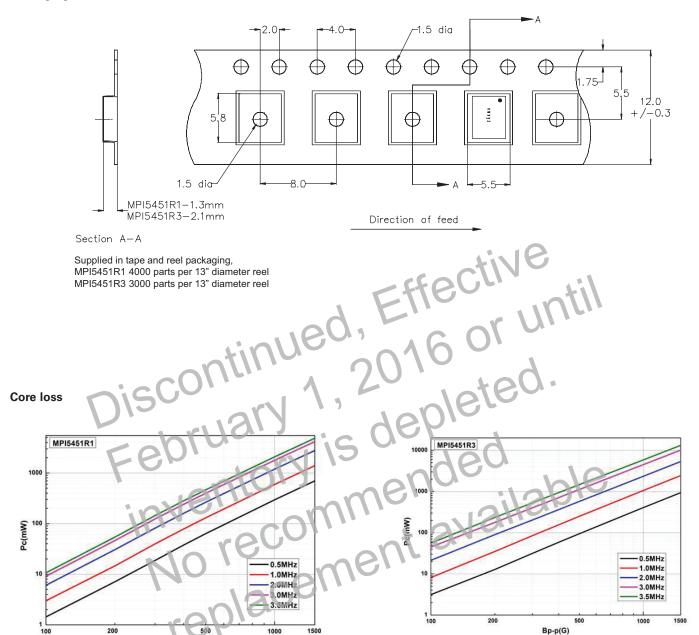
- MPI5451Rx = Product code and size
   yyy= Inductor ce value in uH, R = decimal point, if no R is present then third character = number of zeros
   "-R" suffix = RoHS compliant

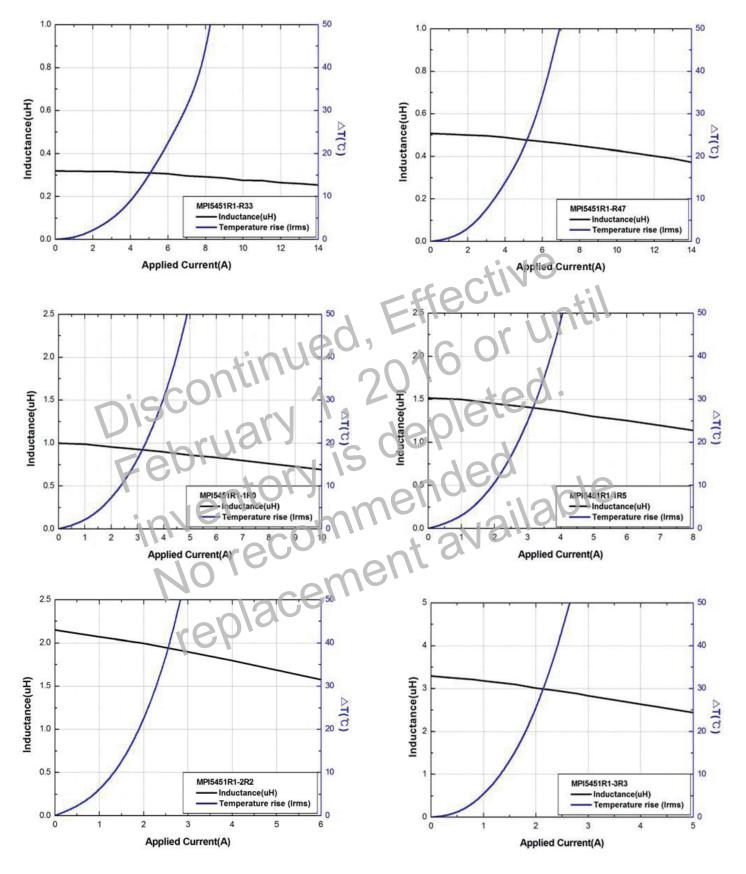
## **Dimensions - mm**

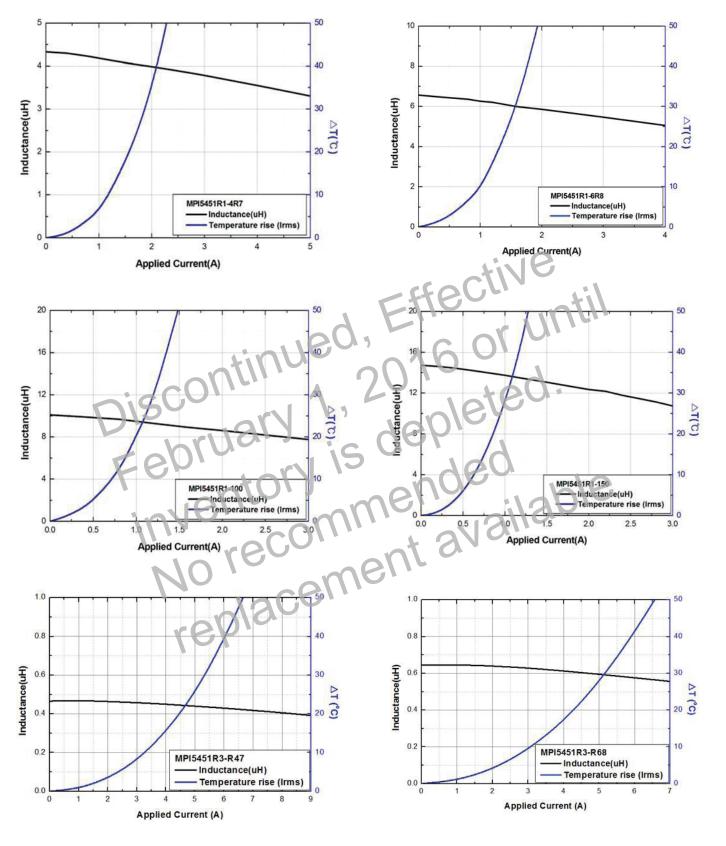


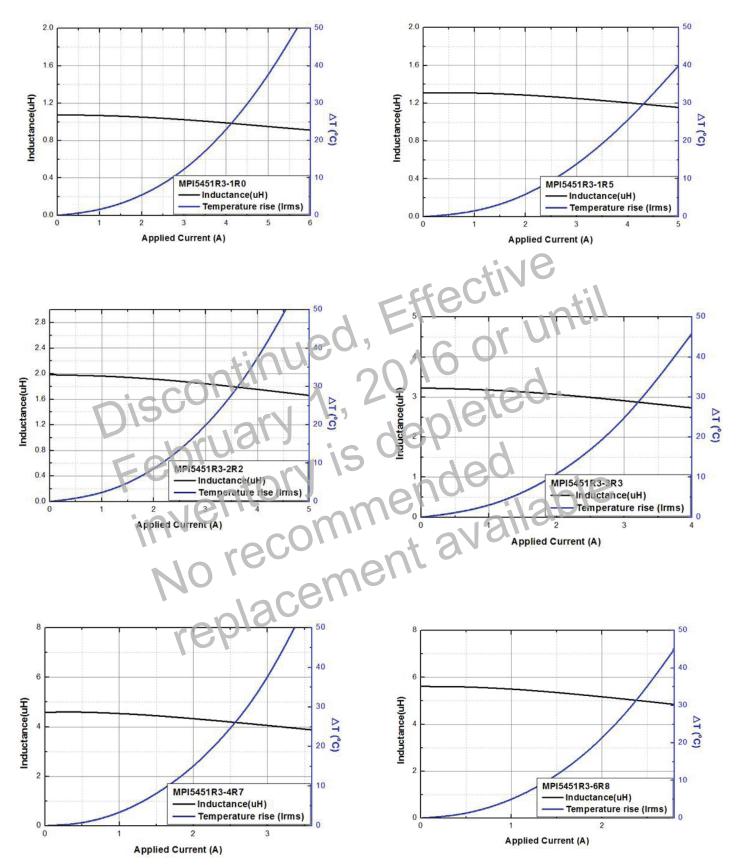
- Part Marking: vwxyz v = height: 1 = R1 (1.2mm), 3 = R3 (2.0mm) w = inductance value per the "Part Marking Designator" letter code in table above x = Bi-weekly date code y = Last digit of year manufactured z = Revision level

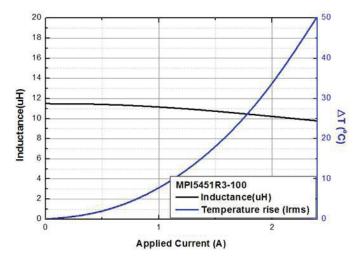
## Packaging information - mm











Discontinued, Effective

Discontinued, Effective

2016 or until

February 1, depleted.

February is depleted.

Inventory is de

## Solder reflow profile

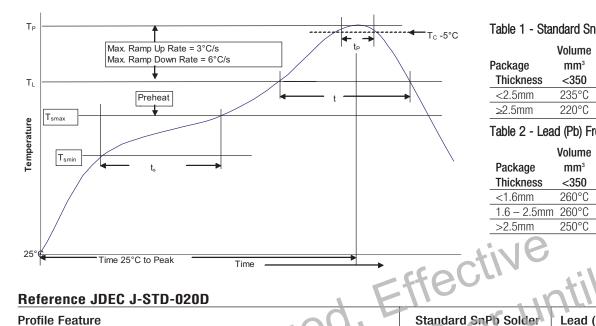


Table 1 - Standard SnPb Solder (T<sub>c</sub>)

	Volume	Volume	
Package	mm³	mm³	
Thickness	<350	≥350	
<2.5mm	235°C	220°C	
≥2.5mm	220°C	220°C	

Table 2 - Lead (Pb) Free Solder (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

## Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak • Temperature min. (T <sub>smin</sub> )	100°C	150°C
<ul> <li>Temperature max. (T<sub>smax</sub>)</li> </ul>	150°C	200°C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds
Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (TL)	183°C	217°C
Time at liquidous (t <sub>L</sub> )	60-150 Seconds	60-150 Seconds
Peak package body temperature (Tp)	Table 1	Table 2
Time $(t_p)^{**}$ within 5 °C of the specified classification to mperature $(T_c)$	20 Seconds**	30 Seconds**
Average ramp-down rate (T <sub>p</sub> to T <sub>sma.</sub> )	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max	8 Minutes Max.

 $<sup>^{\</sup>star}$  Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature  $(t_0)$  is defined as a supplier minimum and a user maximum.

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